LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

Winstar Display Co., LTD 華凌光電股份有限公司



WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER:	~ () •)
MODULE NO.:	WG12864A-YYH-V#N

APPROVED	BY:
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(FOR CUSTOMER USE ONLY)

PCB VERSION:

DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
15			

Ī	VERSION	DATE	REVISED	SUMMARY		
			PAGE NO.			
	I	2019/12/17			Precautions CD Modules	in



MODLE NO:

華凌光電股份有限公司

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSIONDATEREVISED PAGE NO.SUMMARY02006/10/11First issueA2009/06/18Modify Timing CharacteristicsB2013/05/20Remove IC information	
A 2009/06/18 Modify Timing Characteristics B 2013/05/20 Remove IC information	
Characteristics B 2013/05/20 Remove IC information	
B 2013/05/20 Remove IC information	<u> </u>
Modify backlight	
information	
Correct VDD-Vo	
C 2013/07/04 Modify screw hole	
D 2016/01/27 Modify Precautions in u	ıse
of LCD Modules	
& Static electricity test	t
E 2016/04/13 Modify Response Time	
F 2019/03/27 Modify Backlight	
Information	
G 2019/04/25 Modify Backlight	
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H 2019/08/27 Modify Material List of	<u>.</u>
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I 2019/12/17 Modify Precautions in u	ıse
of LCD Modules	

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1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 128 * 64 dot

Model serials no.

 \bigcirc Backlight Type: N \rightarrow Without backlight T \rightarrow LED, White L \rightarrow LED, Full color

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M \rightarrow EL$, Yellow Green $G \rightarrow LED$, Green $H \rightarrow DIP$ LED, Amber $F \rightarrow CCFL$, White $P \rightarrow LED$, Blue $I \rightarrow DIP$ LED, Red

 $Y \rightarrow LED$, Yellow Green $X \rightarrow LED$, Dual color $G \rightarrow LED$, Green $C \rightarrow LED$, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V : Build in Negative Voltage

#: Fit in with the ROHS Directions and regulations

N: IC NT7107C,NT7108C

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

3.General Specification

Item	Dimension	Unit					
Number of dots	128 x 64	_					
Module dimension	93.0 x 70.0 x 13.6 (MAX)	mm					
View area	72.0 x 40.0	72.0 x 40.0 mm					
Active area	66.52 x 33.24	mm					
Dot size	0.48 x 0.48	mm					
Dot pitch	0.52 x 0.52	mm					
LCD type	STN Positive, Yellow Green Transflective (In LCD production, It will occur slightly color can only guarantee the same color in the same by						
Duty	1/64						
View direction	6 o'clock						
Backlight Type	LED, Yellow Green						
IC	NT7107, NT7108						

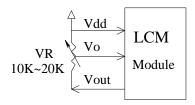
4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}$ C
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Supply Voltage For Logic	V_{DD} - V_{SS}	-0.3	_	7.0	V
Driver Supply Voltage	V_{LCD}	V _{EE} -0.3	_	V _{DD} +0.3	V

5.Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
Supply Voltage For		Ta=-20°C	_	_	10.6	V
LCD	V_{DD} - V_{O}	Ta=25°C	8.6	8.9	9.2	V
*Note		Ta=70°C	7.6	_	_	V
Input High Volt.	V_{IH}	_	$0.7~V_{DD}$	_	V_{DD}	V
Input Low Volt.	V_{IL}	_	0		0.8	V
Output High Volt.	V_{OH}	_	2.4		_	V
Output Low Volt.	V_{OL}			· -	0.4	V
Supply Current	I_{DD}	V _{DD} =5.0V		29.2	_	mA

^{*} Note: Please design the VOP adjustment circuit on customer's main board

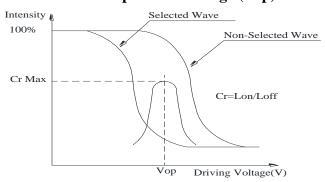


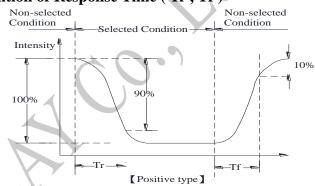
6.Optical Characteristics

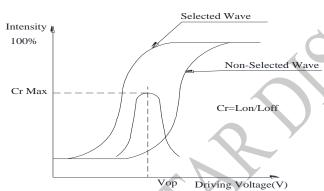
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	$\phi = 180^{\circ}$
View Angle	θ	CR≧2	0	_	40	$\phi = 0^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
D T'	T rise	_	_	200	300	ms
Response Time	T fall	_	_	250	350	ms

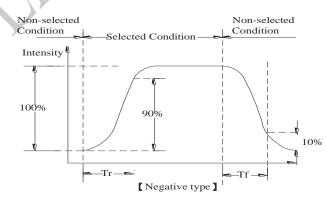
Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)







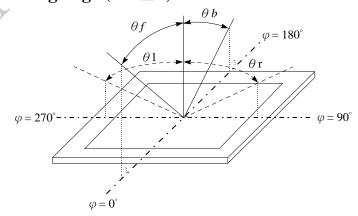


Conditions:

Operating Voltage: Vop Frame Frequency: 64 HZ Viewing Angle(θ , φ): 0° , 0°

Driving Waveform: 1/N duty, 1/a bias

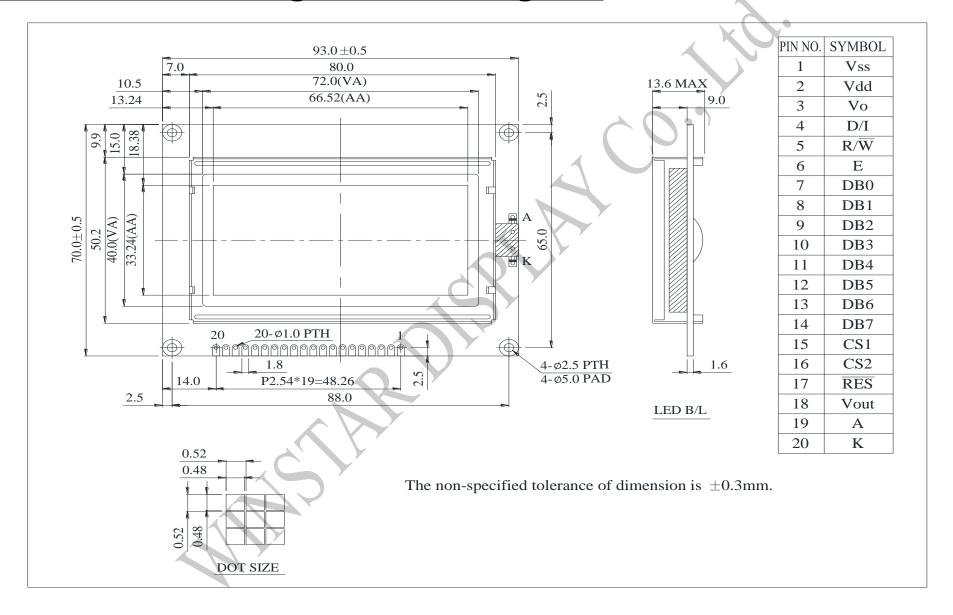
Definition of viewing angle $(CR \ge 2)$

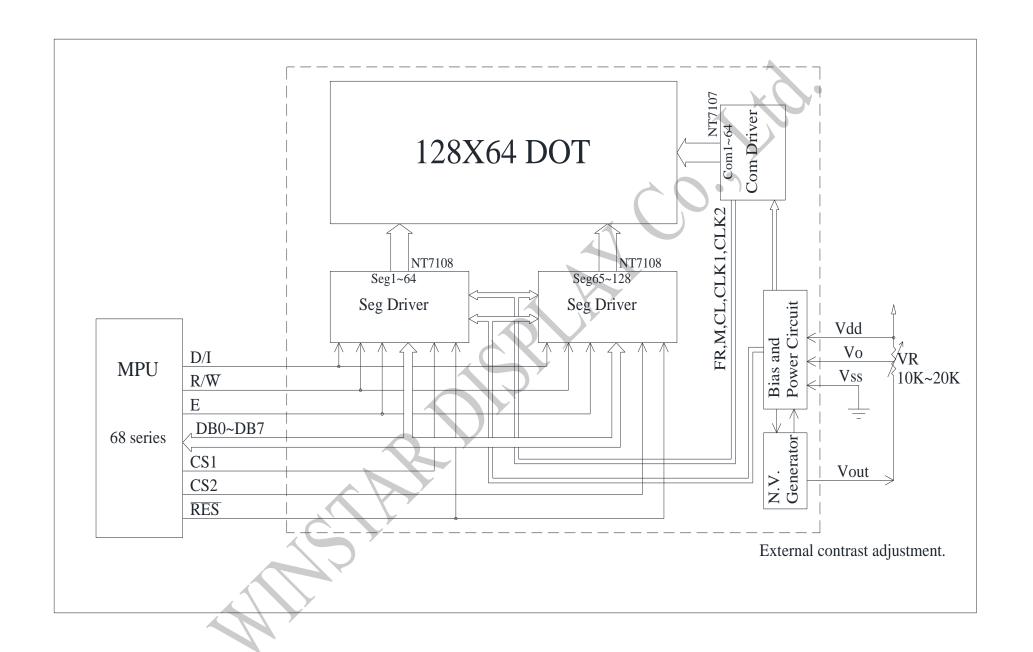


7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	Vss	0V	Ground
2	V_{DD}	5.0V	Supply voltage for logic
3	Vo	(Variable)	Operating voltage for LCD
4	D/I	H/L	H: Data, L: Instruction
5	R/W	H/L	H: Read (MPU←Module) , L: Write (MPU→Module)
6	Е	Н	Enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	CS1	Н	Select Column 1~ Column 64
16	CS2	Н	Select Column 65~ Column 128
17	/RES	L	Reset signal
18	Vout	_	Negative Voltage output
19	A	_	Power Supply for LED backlight (+)
20	K	_	Power Supply for LED backlight (-)

8.Contour Drawing & Block Diagram





9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test							
Test Item	Content of Test	Test Condition	Not e				
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs ▲	2				
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs					
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1				
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90% RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2				
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles					
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3				
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times					

Note1: No dew condensation to be observed.

Note 2: The function test shall be conducted after 4 hours storage at the normal ${\bf r}$

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

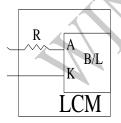
10.Backlight Information

Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	297	330	396	mA	V=4.1V
Supply Voltage	V	3.9	4.1	4.3	V	- × 0
Reverse Voltage	VR	_	_	8	V	-
Luminance (Without LCD)	IV	180	225	_	CD/M ²	ILED=330mA
Wave Length	λp	568	570	574	nm	ILED=330mA
Life Time	_	_	100000	- \	Hr,	ILED≦330mA 25°C,50-60%RH
Color	Yellow Gre	een	6	Y	•	

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

.Drive from pin19,pin20



11.Inspection specification

NO	Item	Criterion				AQL
		Missing vertical	, horizonta	al segment, segme	nt contrast defect.	
		Missing charact	er, dot or	icon.		
		Display malfund	ction.			
01	Electrical	No function or r	no display.			0.65
01	Testing	Current consum	ption exce	eds product specif	fications.	0.03
		LCD viewing ar	ngle defect	•	~ ~ ~	
		Mixed product t	ypes.		4	
		Contrast defect.				
	Black or	2.1 White and h	lack enote	on dienlay < 0.25	mm, no more than	
02	white spots on	three white or b			min, no more than	2.5
02	LCD (display		-	-	or lines within 3mm	2.3
	only)	2.2 Delisery spa		ore than two spots	of the within 5hin	
		3.1 Round type	: As follow	ving drawing		
		$\Phi = (x + y) / 2$		SIZE	Acceptable Q TY	
				Φ≦0.10	Accept no dense	
				$0.10 < \Phi \le 0.20$	2	
				$0.20 < \Phi \le 0.25$	1	2.5
				0.25 < Ф	0	2.3
	LCD black	X				
	spots, white	→	±			
03	spots, winte	• .	∓ Y			
05	contamination		T			
	(non-display)	3.2 Line type : (As follow:	ing drawing)		
			Length	Width	Acceptable Q TY	
		_ /¥ w		W≦0.02	Accept no dense	
4		→ I H—	L≦3.0	$0.02 < W \le 0.03$		2.5
		1.0	L≦2.5	$0.03 < W \le 0.05$		2.5
				0.05 < W	As round type	
				•		

04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5
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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 LCD blace	ck spots, white spots, co	ntamination	
		Symbols Define:	. Chin width	in this leases	
			=	ip thickness	
			Glass thickness a: LC	D side length	
		L: Electrode pad length	1:		
		6.1 General glass chip:	:		
		6.1.1 Chip on panel sur	face and crack between	panels:	
			N. C.		
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x ≤ 1/8a	2.5
	glass	$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	
		⊙ If there are 2 or more 6.1.2 Corner crack:	e chips, x is total length	of each chip.	
			T	T	
4		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	$x \le 1/8a$	
		$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	
		⊙ If there are 2 or more	e chips, x is the total len	gth of each chip.	

NO	Item	Criterion			AQL
		Symbols:			
		•	ip width z: Chip	thickness	
			-	side length	
		L: Electrode pad length		•	
		6.2 Protrusion over termina	1:		
		6.2.1 Chip on electrode pad	l:		
06	Glass		≦ 1/8a	$\frac{z}{z} \stackrel{\text{Chip thickness}}{\text{Chip thickness}}$	2.5
		y: Chip width	x: Chip length	z: Chip thickness	
		$y \le L$	$x \le 1/8a$	$0 < z \le t$	
		⊙ If the chipped area touch remain and be inspected acc			
	4		_	<u>-</u>	
		be damaged.	it seared by the eastorn	er, the angilinent mark not	
4		6.2.3 Substrate protuberanc	e and internal crack.		
		X		1 1	
			y: width	x: length	
			y≤1/3L	$x \leq a$	
		12			

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
00	Backlight	8.2 Spots or scratched that appear when lit must be judged.	2.5
08	elements	Using LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the	2.5
		seal area on the PCB. And there should be no more than three	
		places.	
		10.5 No oxidation or contamination PCB terminals.	2.5
10	PCB、COB	10.6 Parts on PCB must be the same as on the production	0.65
10	TCD COD	characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5
		screw hold pad, make sure it is smoothed down.	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
	15	X	
		$X * Y \le 2mm^2$	
4		11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections,	2.5
11	Soldering	oxidation or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limit	ted va	lue is s	set up a	accord	ing to F	RoHS.	A			

- 2.Process for RoHS requirement : (only for RoHS inspection)
 - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
 - (2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. $: 235\pm5^{\circ}C$;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.



winstar <u>LCM Samp</u> Module Number:		Feedback Sheet Page: 1
1 · Panel Specification :		Tuge. I
1. Panel Type:	Pass	□ NG ,
2. View Direction:	Pass	□ NG ,
3. Numbers of Dots:	Pass	□ NG ,
4. View Area:	☐ Pass	□ NG ,
5. Active Area:	Pass	□ NG ,
6. Operating Temperature:	Pass	□ NG,
7. Storage Temperature :	Pass	□ NG,
8. Others:		
2 · Mechanical Specification :		
1. PCB Size:	Pass	□ NG,
2. Frame Size:	Pass	□ NG,
3. Materal of Frame:	Pass	□ NG,
4. Connector Position:	Pass	□ NG,
5. Fix Hole Position:	Pass	□ NG,
6. Backlight Position:	☐ Pass	□ NG,
7. Thickness of PCB:	☐ Pass	□ NG ,
8. Height of Frame to PCB:	☐ Pass	□ NG ,
9. Height of Module:	Pass	□ NG,
10. Others:	☐ Pass	□ NG ,
3 · Relative Hole Size :		
1. Pitch of Connector :	☐ Pass	□ NG ,
2. Hole size of Connector:	Pass	□ NG ,
3. Mounting Hole size:	Pass	□ NG ,
4. Mounting Hole Type:	Pass	□ NG ,
5. Others:	Pass	□ NG ,
4 · Backlight Specification :		
1. B/L Type:	Pass	☐ NG ,
2. B/L Color:	Pass	☐ NG ,
3. B/L Driving Voltage (Refere	ence for LED	Гуре):
4. B/L Driving Current:	Pass	☐ NG ,
5. Brightness of B/L:	Pass	□ NG ,
6. B/L Solder Method:	Pass	☐ NG ,
7. Others:	Pass	☐ NG ,
	>> Go to	page 2 <<

ไกดม	le Number:		Page: 2
	Electronic Characteristics of		1 ugo. 2
	Input Voltage:	Pass	□ NG ,
2.		Pass	□ NG ,
3.		☐ Pass	□ NG ,
4.	Contrast for LCD:	☐ Pass	□ NG ,
5.	B/L Driving Method:	☐ Pass	□ NG ,
6.	Negative Voltage Output:	☐ Pass	□ NG ,
7.		☐ Pass	□ NG ,
8.	LCD Uniformity:	☐ Pass	□ NG ,
9.	ESD test:	☐ Pass	□ NG ,
10.	Others:	☐ Pass	□ NG ,
6、	Summary :		